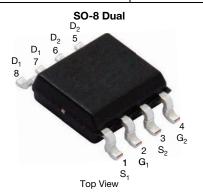


AP9971AGM-VB Datasheet Dual N-Channel 60 V (D-S) 175 °C MOSFET

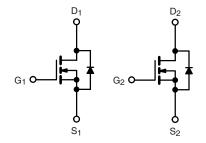
PRODUCT SUMMARY					
V _{DS} (V)	60				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.028				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.030				
I _D (A) per leg	7				
Configuration	Dual				



FEATURES

- TrenchFET® power MOSFET
- \bullet 100 % R_g and UIS tested





N-Channel MOSFET N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	(T _C = 25 °C, unles	s otherwise noted)	
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20		
Continuous Drain Current	T _C = 25 °C	1	7	
Continuous Drain Current	T _C = 125 °C	- I _D	4	
Continuous Source Current (Diode Conduction) a		I _S	3.6	Α
Pulsed Drain Current ^b		I _{DM}	28	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	18	
Single Pulse Avalanche Energy	L = 0.1 IIII	E _{AS}	16.2	mJ
Maximum Power Dissipation ^b	T _C = 25 °C	р	4	W
	T _C = 125 °C	- P _D	1.3	VV
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount ^c	R_{thJA}	110	°C/W	
Junction-to-Foot (Drain)		R_{thJF}	34	C/ VV	

Notes

- a. Package limited.
- b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- c. When mounted on 1" square PCB (FR4 material).

服务热线:400-655-8788

1



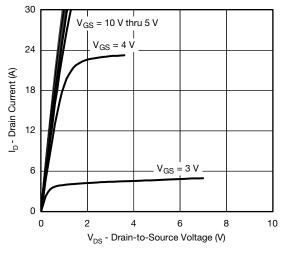
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60	-	-	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		2.0	2.5	V
Gate-Source Leakage	I _{GSS}	V _{DS} =	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = 60 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	-	-	50	μΑ
		$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$	-	-	150	
On-State Drain Current ^a	I _{D(on)}	$V_{GS} = 10 \text{ V}$	V _{DS} ≥ 5 V	20	-	-	Α
		V _{GS} = 10 V	I _D = 4.5 A-	-	0.028	-	Ω
Drain-Source On-State Resistance a	R _{DS(on)}	$V_{GS} = 10 \text{ V}$	I _D = 4.5 A, T _J = 125 °C	-	0.066	-	
	03(01)	V _{GS} = 10 V	I _D = 4.5 A, T _J = 175 °C	-	0.081	-	
		$V_{GS} = 4.5 \text{ V}$	I _D = 4 A-	-	0.030	-	
Forward Transconductance f	9fs	$V_{DS} = 15 \text{ V}, I_D = 4.5 \text{ A}$		-	15	-	S
Dynamic ^b		,			1		
Input Capacitance	C _{iss}			-	600	750	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	-	110	140	
Reverse Transfer Capacitance	C _{rss}			-	50	62	
Total Gate Charge ^c	Qg			-	11.7	18	
Gate-Source Charge ^c	Q _{gs}	V _{GS} = 10 V	$V_{DS} = 30 \text{ V}, I_D = 5.3 \text{ A}$	-	1.8	2.7	nC
Gate-Drain Charge ^c	Q _{gd}	1		-	2.8	4.2	
Gate Resistance	R_g		f = 1 MHz		-	6	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	7	11	
Rise Time °	t _r	$V_{DD} = 30 \text{ V, } R_L = 6.8 \Omega$ $I_D \cong 4.4 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 1 \Omega$		-	3.3	5	- ns
Turn-Off Delay Time ^c	t _{d(off)}			-	22.4	33.5	
Fall Time ^c	t _f			-	2.1	3.2	
Source-Drain Diode Ratings and Chara	acteristics b				L		
Pulsed Current a	I _{SM}			-	-	28	Α
Forward Voltage	V _{SD}	I _F = 2 A, V _{GS} = 0 V		-	0.75	1.1	V

Notes

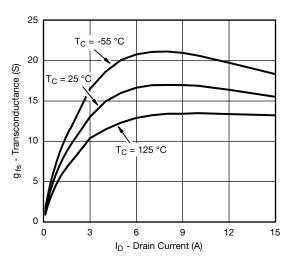
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.



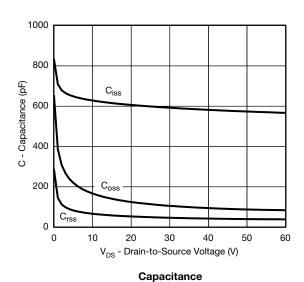
TYPICAL CHARACTERISTICS ($T_A = 25 \, ^{\circ}\text{C}$, unless otherwise noted)



Output Characteristics

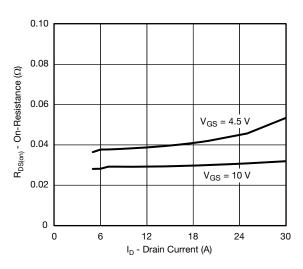


Transconductance

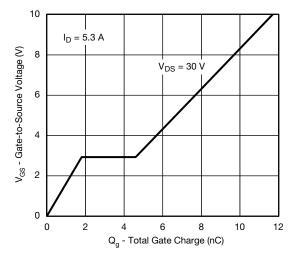


30 24 (Y) tip 18 18 T_C = 25 °C T_C = 125 °C T_C = -55 °C V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics



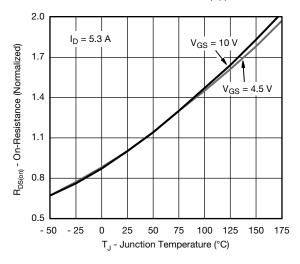
On-Resistance vs. Drain Current



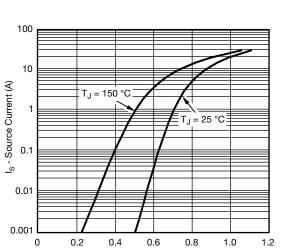
Gate Charge



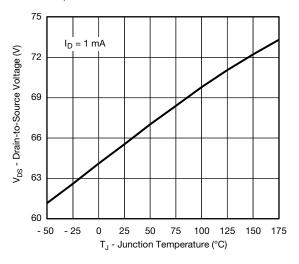
TYPICAL CHARACTERISTICS ($T_A = 25 \, ^{\circ}\text{C}$, unless otherwise noted)



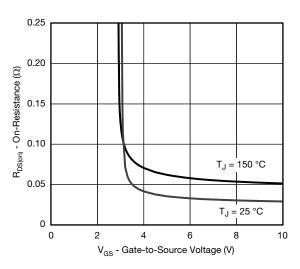
On-Resistance vs. Junction Temperature



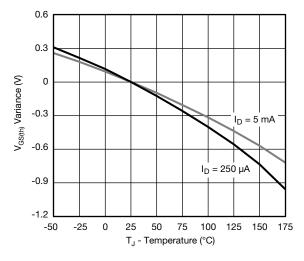
 V_{SD} - Source-to-Drain Voltage (V) Source Drain Diode Forward Voltage



Drain Source Breakdown vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

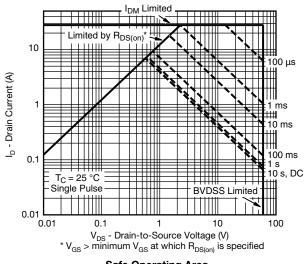


Threshold Voltage

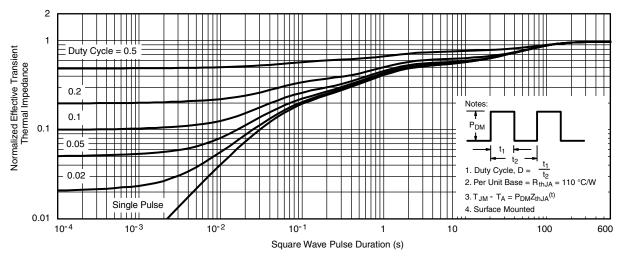


5

THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



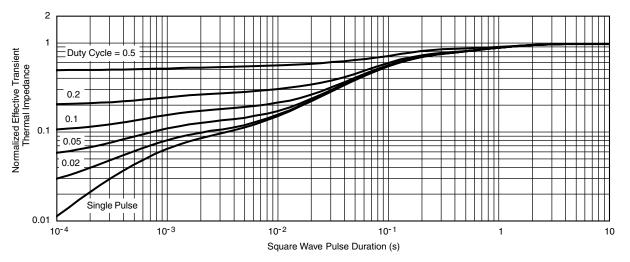
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



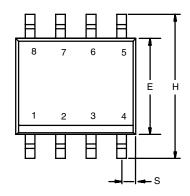
THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)

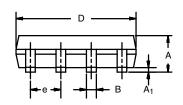


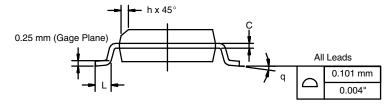
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





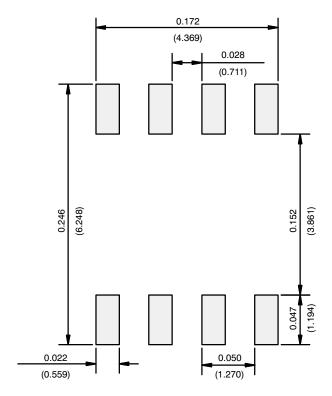


	MILLIMETERS INCHES			HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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